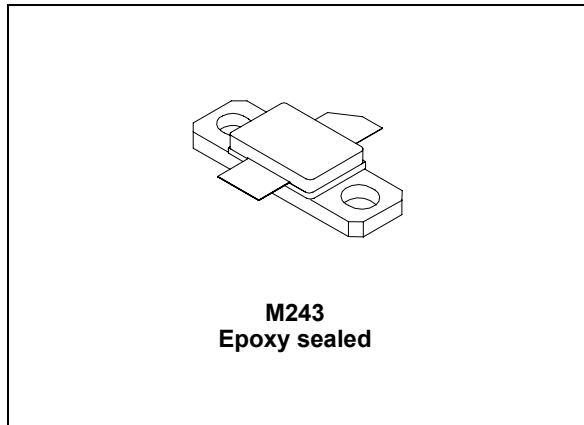


## RF power transistor, LdmoST family

## Features

- Excellent thermal stability
  - Common source configuration
  - $P_{OUT} = 15 \text{ W}$  with 11 dB gain @ 2 GHz / 13.6 V
  - BeO free package
  - ESD protection
  - In compliance with the 2002/95/EC european directive

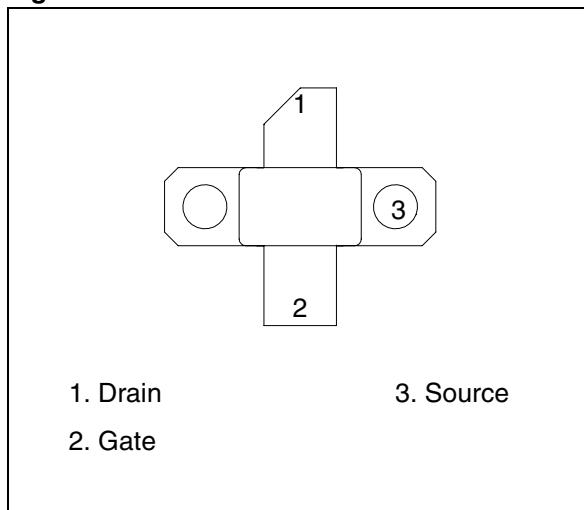


## Description

The PD20015C is a common source N-channel, enhancement-mode lateral field-effect RF power transistor. It is designed for high gain, broadband commercial and industrial applications. It operates at 13.6 V in common source mode at frequencies of up to 2 GHz. PD20015C boasts the excellent gain, linearity and reliability of ST's latest LDMOS technology.

PD20015C's superior linearity performance makes it an ideal solution for mobile application.

**Figure 1.** Pin connection



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## 1 Electrical data

### 1.1 Maximum ratings

$T_{CASE} = 25 \text{ }^{\circ}\text{C}$

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{(BR)DSS}$	Drain-source voltage	40	V
$V_{GS}$	Gate-source voltage	- 0.5 to 15	V
$I_D$	Drain current	7	A
$P_{DISS}$	Power dissipation (@ $T_C = 70 \text{ }^{\circ}\text{C}$ )	93	W
$T_J$	Max. operating junction temperature	200	$^{\circ}\text{C}$
$T_{STG}$	Storage temperature	-65 to +150	$^{\circ}\text{C}$

### 1.2 Thermal data

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thJC}$	Junction - case thermal resistance	1.4	$^{\circ}\text{C/W}$

## 2 Electrical characteristics

$T_{CASE} = +25^\circ\text{C}$

### 2.1 Static

**Table 4. Static**

Symbol	Test conditions		Min.	Typ.	Max.	Unit
$I_{DSS}$	$V_{GS} = 0 \text{ V}$	$V_{DS} = 25 \text{ V}$	-		1	$\mu\text{A}$
$I_{GSS}$	$V_{GS} = 5 \text{ V}$	$V_{DS} = 0 \text{ V}$	-		1	$\mu\text{A}$
$V_{GS(Q)}$	$V_{DS} = 10 \text{ V}$	$I_D = 350 \text{ mA}$	-	4.2		V
$V_{DS(ON)}$	$V_{GS} = 10 \text{ V}$	$I_D = 1 \text{ A}$	-	270	310	mV
$C_{ISS}$	$V_{GS} = 0 \text{ V}$	$V_{DS} = 12.5 \text{ V}$	$f = 1 \text{ MHz}$	-	49	pF
$C_{OSS}$	$V_{GS} = 0 \text{ V}$	$V_{DS} = 12.5 \text{ V}$	$f = 1 \text{ MHz}$	-	35	pF
$C_{RSS}$	$V_{GS} = 0 \text{ V}$	$V_{DS} = 12.5 \text{ V}$	$f = 1 \text{ MHz}$	-	1.0	pF

### 2.2 Dynamic

**Table 5. Dynamic**

Symbol	Test conditions	Min.	Typ.	Max.	Unit
P3dB	$V_{DD} = 13.6 \text{ V}$ , $I_{DQ} = 350 \text{ mA}$ $f = 2 \text{ GHz}$		23	-	W
$G_P$	$V_{DD} = 13.6 \text{ V}$ , $I_{DQ} = 350 \text{ mA}$ , $P_{OUT} = 15 \text{ W}$ , $f = 2 \text{ GHz}$	10	11	-	dB
$h_D$	$V_{DD} = 13.6 \text{ V}$ , $I_{DQ} = 350 \text{ mA}$ , $P_{OUT} = P3dB$ , $f = 2 \text{ GHz}$	45	53	-	%
Load mismatch	$V_{DD} = 15.5 \text{ V}$ , $I_{DQ} = 350 \text{ mA}$ , $P_{OUT} = 20 \text{ W}$ , $f = 2 \text{ GHz}$ All phase angles	20:1		-	VSWR

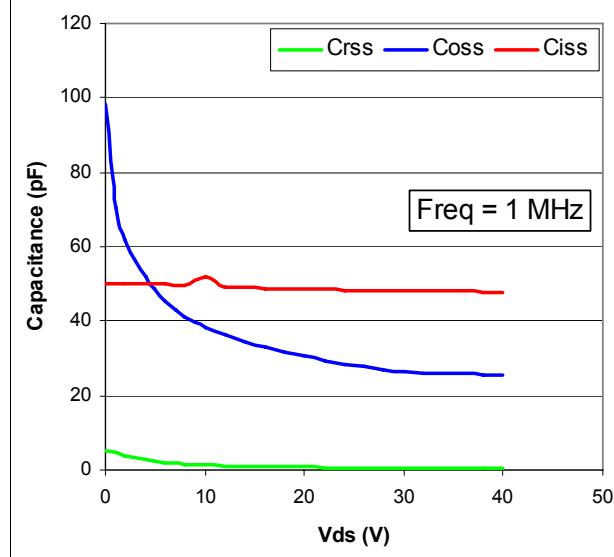
### 2.3 ESD protection characteristics

**Table 6. ESD protection characteristics**

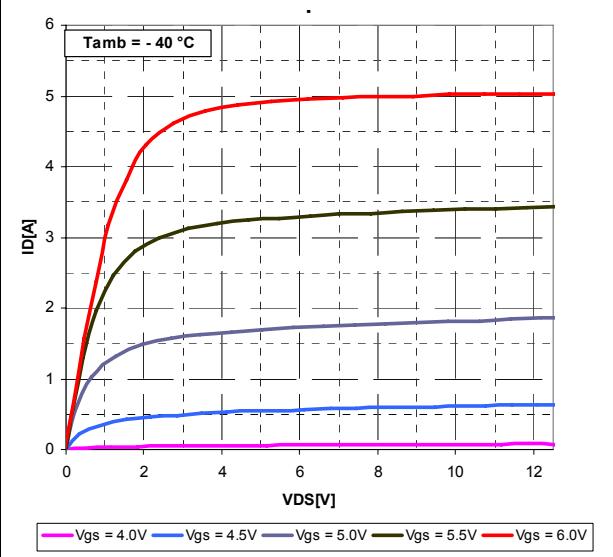
Test conditions	Class
Human body model	2
Machine model	M3

### 3 Typical performance

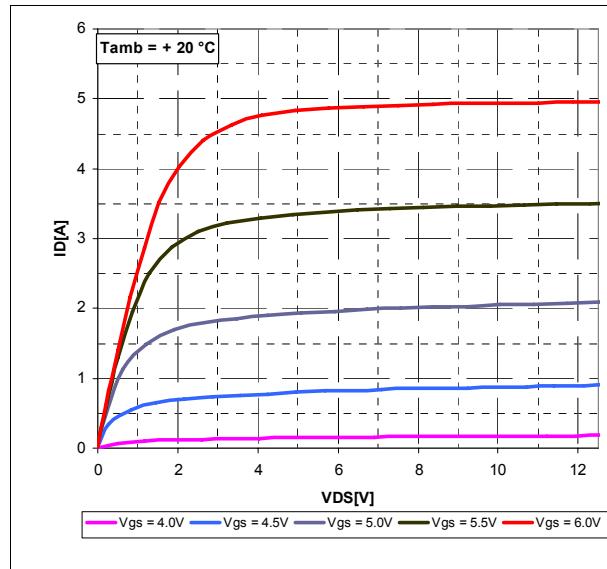
**Figure 2. Capacitances vs drain voltage**



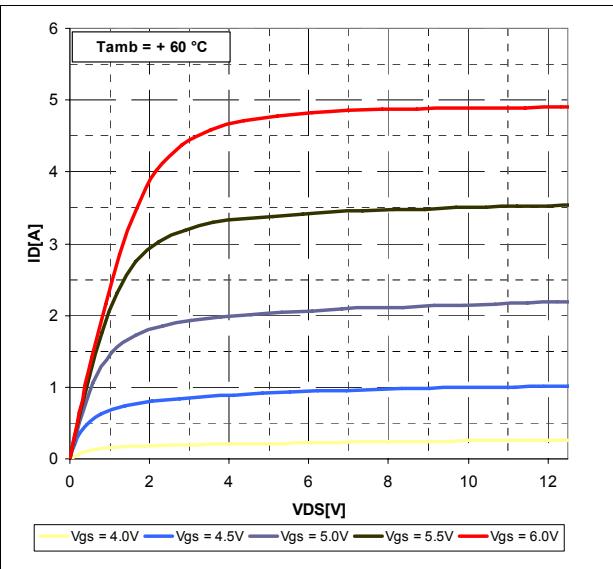
**Figure 3. DC output characteristics**

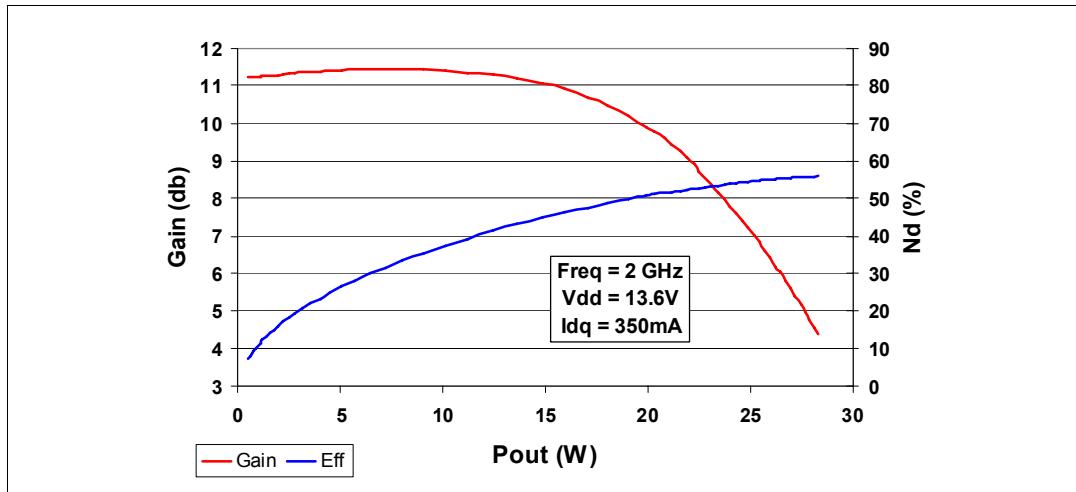
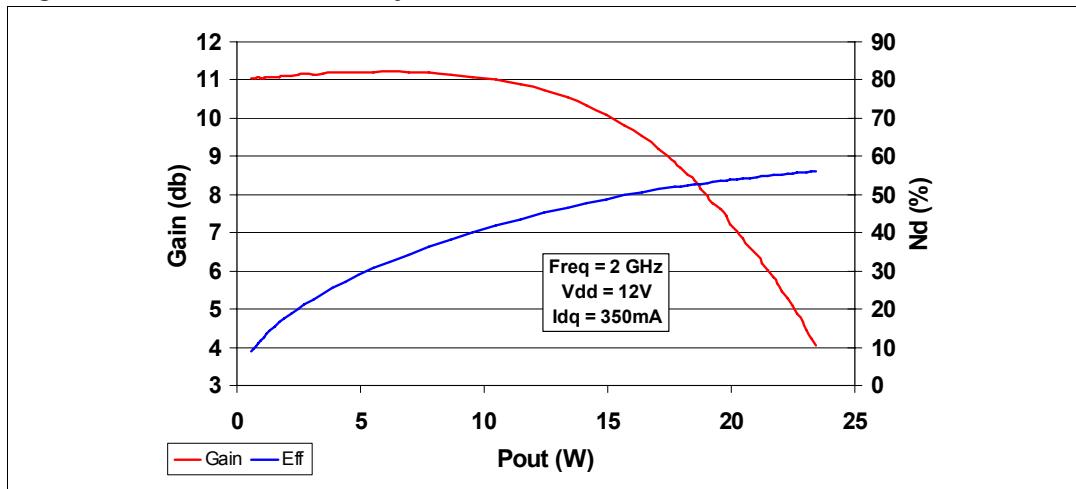


**Figure 4. DC output characteristics**



**Figure 5. DC output characteristic**



**Figure 6. Gain and efficiency vs Pout****Figure 7. Gain and efficiency vs Pout**

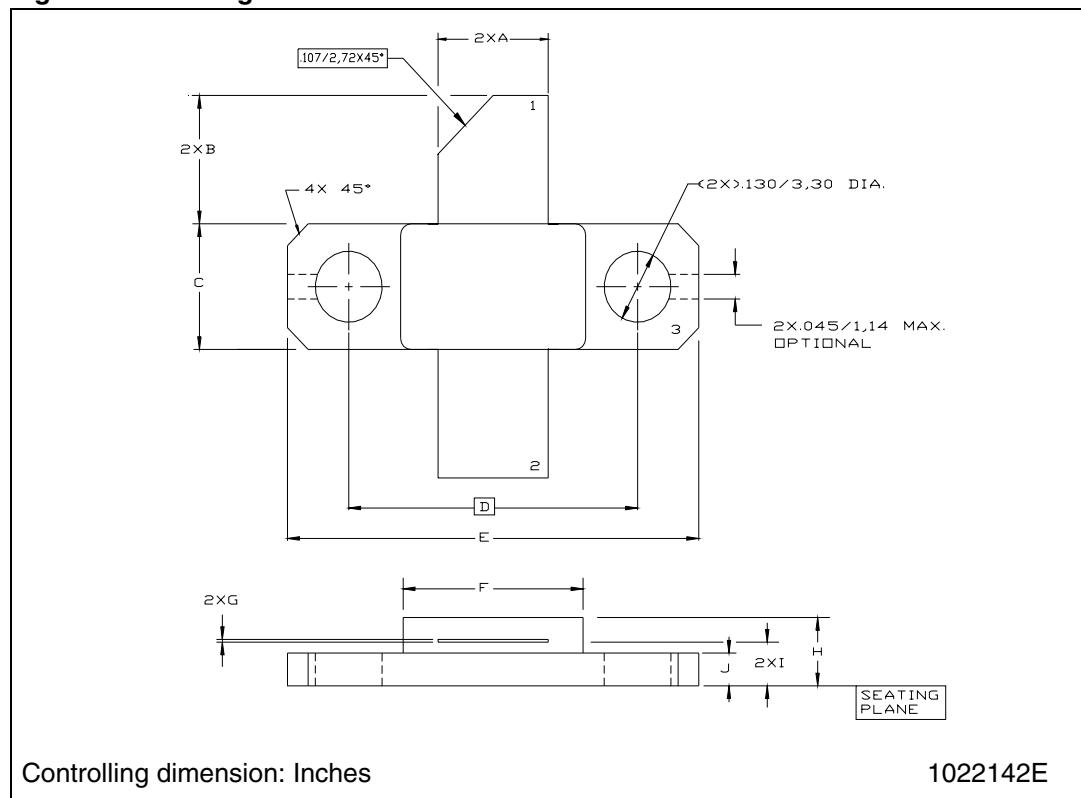
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
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**Table 7. M243 (0.230 x 0.360 2L N/HERM W/FLG) mechanical data**

Dim.	mm.			Inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	5.21		5.72	0.205		0.225
B	5.46		6.48	0.215		0.255
C	5.59		6.10	0.220		0.240
D		14.27			0.562	
E	20.07		20.57	0.790		0.810
F	8.89		9.40	0.350		0.370
G	0.10		0.15	0.004		0.006
H	3.18		4.45	0.125		0.175
I	1.83		2.24	0.072		0.088
J	1.27		1.78	0.050		0.070

**Figure 8. Package dimensions**



## 5 Revision history

**Table 8. Document revision history**

Date	Revision	Changes
16-Nov-2007	1	Initial release.
14-Apr-2009	2	Updated <a href="#">Table 4 on page 4</a>

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